



SLES102A - DECEMBER 2003 - REVISED NOVEMBER 2006

24-BIT, 192-kHz SAMPLING, ADVANCED SEGMENT, AUDIO STEREO DIGITAL-TO-ANALOG CONVERTER

FEATURES

- 24-Bit Resolution
- Analog Performance:
 - Dynamic Range: 123 dB
 - THD+N: 0.0005%
- Differential Current Output: 4 mA p-p
- 8× Oversampling Digital Filter:
 - Stop-Band Attenuation: -98 dB
 - Pass-Band Ripple: ±0.0002 dB
- Sampling Frequency: 10 kHz to 200 kHz
- System Clock: 128, 192, 256, 384, 512, or 768 f_S With Autodetect
- Accepts 16- and 24-Bit Audio Data
- PCM Data Formats: Standard, I²S, and Left-Justified
- Interface Available for Optional External Digital Filter or DSP
- Digital De-Emphasis
- Digital Filter Rolloff: Sharp or Slow
- Soft Mute
- Zero Flag
- Dual-Supply Operation: 5-V Analog, 3.3-V Digital

- 5-V Tolerant Digital Inputs
- Small 28-Lead SSOP Package
- Pin Assignment Compatible With PCM1794

APPLICATIONS

- A/V Receivers
- DVD Players
- Musical Instruments
- HDTV Receivers
- Car Audio Systems
- Digital Multitrack Recorders
- Other Applications Requiring 24-Bit Audio

DESCRIPTION

The PCM1798 is a monolithic CMOS integrated circuit that includes stereo digital-to-analog converters and support circuitry in a small 28-lead SSOP package. The data converters use TI's advanced segment DAC architecture to achieve excellent dynamic performance and improved tolerance to clock jitter. The PCM1798 provides balanced current outputs, allowing the user to optimize analog performance externally. Sampling rates up to 200 kHz are supported.



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



ORDERING INFORMATION

PRODUCT	PACKAGE	PACKAGE CODE	OPERATION TEMPERATURE RANGE PACKAGE MARKING		ORDERING NUMBER	TRANSPORT MEDIA
DCM4700DD	00 lood 000D	28DB	0500 +- 0500	DOM4700	PCM1798DB	Tube
PCM1798DB	28-lead SSOP		–25°C to 85°C	PCM1798	PCM1798DBR	Tape and reel

ABSOLUTE MAXIMUM RATINGS

over operating free-air temperature range unless otherwise noted(1)

_		PCM1798
Cumply voltage	V _{CC} 1, V _{CC} 2L, V _{CC} 2R	−0.3 V to 6.5 V
Supply voltage	V _{DD}	−0.3 V to 4 V
Supply voltage differen	nces: V _{CC} 1, V _{CC} 2L, V _{CC} 2R	±0.1 V
Ground voltage differe	ences: AGND1, AGND2, AGND3L, AGND3R, DGND	±0.1 V
Digital input valtage	LRCK, DATA, BCK, SCK, FMT1, FMT0, MONO, CHSL, DEM, MUTE, RST,	−0.3 V to 6.5 V
Digital input voltage	ZERO	-0.3 V to (V _{DD} + 0.3 V) < 4 V
Analog input voltage		$-0.3 \text{ V to } (\text{V}_{\text{CC}} + 0.3 \text{ V}) < 6.5 \text{ V}$
Input current (any pins	s except supplies)	±10 mA
Ambient temperature	under bias	−40°C to 125°C
Storage temperature		–55°C to 150°C
Junction temperature	150°C	
Lead temperature (sol	260°C, 5 s	
Package temperature	260°C	

⁽¹⁾ Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

all specifications at $T_A = 25^{\circ}C$, $V_{CC}1 = V_{CC}2L = V_{CC}2R = 5$ V, $V_{DD} = 3.3$ V, $f_S = 44.1$ kHz, system clock = 256 f_S , and 24-bit data, unless otherwise noted

	D4.D.4.4.ETED	TEST CONDITIONS		PCM1798DB		
PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
RES	OLUTION		24		Bits	
DAT	A FORMAT	·				
	Audio data interface format		Standard	d, I ² S, left-	justified	
	Audio data bit length		16-, 2	4-bit selec	table	
	Audio data format		MSB first, 2s complement			
fs	Sampling frequency		10		200	kHz
	System clock frequency		128, 192, 2	256, 384, 5	12, 768 f _S	
DIGI	TAL INPUT/OUTPUT	·				
	Logic family		TTI	L compatib	ole	
V_{IH}	long t logic logol		2			VDC
VIL	Input logic level				0.8	VDC
lн	Input logic current	$V_{IN} = V_{DD}$			10	
IIL	Input logic current	V _{IN} = 0 V			-10	μΑ
Vон	Output logic lovel	$I_{OH} = -2 \text{ mA}$	2.4			VDC
VOL	Output logic level	I _{OL} = 2 mA			0.4	VDC



ELECTRICAL CHARACTERISTICS (Continued)

all specifications at $T_A = 25^{\circ}C$, $V_{CC}1 = V_{CC}2L = V_{CC}2R = 5 \text{ V}$, $V_{DD} = 3.3 \text{ V}$, $f_S = 44.1 \text{ kHz}$, system clock = 256 f_S , and 24-bit data, unless otherwise noted

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
YNAMIC PERFORMANCE (1)(2)				<u> </u>	
	f _S = 44.1 kHz		0.0005%	0.001%	
THD+N at $V_{OUT} = 0 \text{ dB}$	$f_S = 96 \text{ kHz}$		0.001%		
	f _S = 192 kHz		0.0015%		
	EIAJ, A-weighted, fg = 44.1 kHz	120	123		
Dynamic range	EIAJ, A-weighted, fg = 96 kHz		123		dB
	EIAJ, A-weighted, fg = 192 kHz		123		
	EIAJ, A-weighted, fg = 44.1 kHz	120	123		
Signal-to-noise ratio	EIAJ, A-weighted, fg = 96 kHz		123		dB
	EIAJ, A-weighted, f _S = 192 kHz		123		
	f _S = 44.1 kHz	116 119			
Channel separation	f _S = 96 kHz		118		dB
	f _S = 192 kHz		117		
Level linearity error	V _{OUT} = −120 dB		±1		dB
NAMIC PERFORMANCE (MONO MODE	E) (1)(2)(3)				
	f _S = 44.1 kHz		0.0005%		
THD+N at $V_{OUT} = 0 \text{ dB}$	f _S = 96 kHz		0.001%		
	f _S = 192 kHz		0.0015%		
	EIAJ, A-weighted, f _S = 44.1 kHz		126		
Dynamic range	EIAJ, A-weighted, f _S = 96 kHz		126		dB
	EIAJ, A-weighted, fg = 192 kHz		126		
	EIAJ, A-weighted, f _S = 44.1 kHz		126		
Signal-to-noise ratio	EIAJ, A-weighted, fg = 96 kHz		126		dB
	EIAJ, A-weighted, fg = 192 kHz		126		

⁽¹⁾ Filter condition:

THD+N: 20-Hz HPF, 20-kHz AES17 LPF

Dynamic range: 20-Hz HPF, 20-kHz AES17 LPF, A-weighted Signal-to-noise ratio: 20-Hz HPF, 20-kHz AES17 LPF, A-weighted

Channel separation: 20-Hz HPF, 20-kHz AES17 LPF

Analog performance specifications are measured using the System Two™ Cascade audio measurement system by Audio Precision™ in the averaging mode.

- (2) Dynamic performance and dc accuracy are specified at the output of the postamplifier as shown in Figure 24.
- (3) Dynamic performance and dc accuracy are specified at the output of the measurement circuit as shown in Figure 25.



ELECTRICAL CHARACTERISTICS (Continued) all specifications at $T_A = 25^{\circ}\text{C}$, $V_{CC}1 = V_{CC}2L = V_{CC}2R = 5 \text{ V}$, $V_{DD} = 3.3 \text{ V}$, $f_S = 44.1 \text{ kHz}$, system clock = 256 f_S , and 24-bit data, unless otherwise noted

	PARAMETER	TEST CONDITIONS	P	CM1798E	В	UNIT
	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
ANALO	OG OUTPUT					
	Gain error		-7	±2	7	% of FSI
	Gain mismatch, channel-to-channel		-3	±0.5	3	% of FSI
	Bipolar zero error	At BPZ	-2	±0.5	2	% of FS
	Output current	Full scale (0 dB)		4		mA p-p
	Center current	At BPZ		-3.5		mA
DIGITA	L FILTER PERFORMANCE					
	De-emphasis error				±0.1	dB
FILTER	CHARACTERISTICS-1: SHARP ROLLO	OFF	<u> </u>			1
		±0.0002 dB			0.454 fs	
	Pass band	-3 dB			0.49 f _S	1
	Stop band		0.546 fs			
	Pass-band ripple				±0.0002	dB
	Stop-band attenuation	Stop band = 0.546 fs	-98			dB
	Delay time			38/f _S		S
FILTER	CHARACTERISTICS-2: SLOW ROLLO	FF	l			
		±0.001 dB			0.21 fg	
	Pass band	-3 dB			0.448 fs	İ
	Stop band		0.79 fg			
	Pass-band ripple				±0.001	dB
	Stop-band attenuation	Stop band = 0.732 fs	-80			dB
	Delay time			38/f _S		s
POWER	R SUPPLY REQUIREMENTS		l			
V_{DD}			3	3.3	3.6	VDC
V _{CC} 1	1					
V _{CC} 2L	Voltage range		4.75	5	5.25	VDC
V _{CC} 2R						
		f _S = 44.1 kHz		7	9	
lDD		f _S = 96 kHz		13		mA
	2 (1)	f _S = 192 kHz		25		1
	Supply current (1)	f _S = 44.1 kHz		18	23	
lcc		f _S = 96 kHz		19		mA
		f _S = 192 kHz		20		1
	1	f _S = 44.1 kHz		115	150	
	Power dissipation (1)	f _S = 96 kHz		140		mW
	·	f _S = 192 kHz		180		1
TEMPE	RATURE RANGE		I.			
	Operation temperature		-25		85	°C
θЈΑ	Thermal resistance	28-pin SSOP		100		°C/W

⁽¹⁾ Input is BPZ data.



PIN ASSIGNMENTS

	PCM1798 (TOP VIEW)		
MONO CHSL CHSL CHSL CHSL CHSL CHSL CHSL CHSL		28 27 26 25 24 23 22 21 20	V _{CC} ² L AGND3L I _{OUT} L- I _{OUT} L+ AGND2 V _{CC} ¹ V _{COM} L V _{COM} R I _{REF}
MUTE FMT0 FMT1	10 11 12	19 18 17	AGND1 I _{OUT} R- I _{OUT} R+
FMT0		18	□□ AGND1
ZERO CCC	13 14	16 15	AGND3R U _{CC} 2R



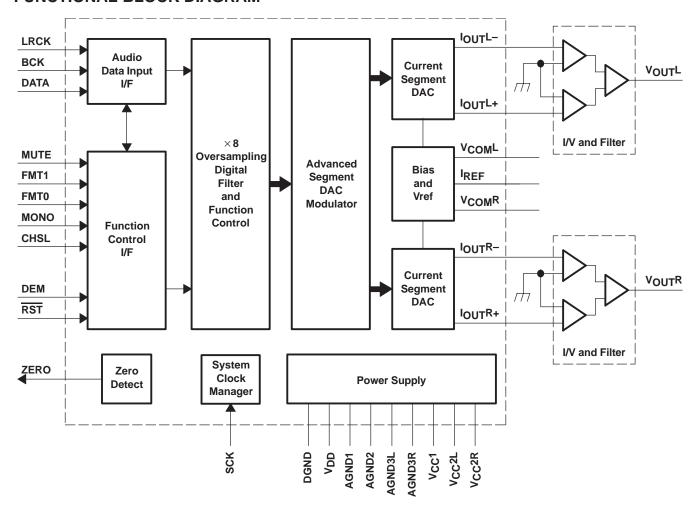
Terminal Functions

TERMINAL						
NAME	PIN	1/0	DESCRIPTIONS			
AGND1	19	_	Analog ground (internal bias)			
AGND2	24	_	nalog ground (internal bias)			
AGND3L	27	_	Analog ground (L-channel DACFF)			
AGND3R	16	İ –	Analog ground (R-channel DACFF)			
BCK	6	1	Bit clock input (1)			
CHSL	2	- 1	L-, R-channel select (1)			
DATA	5	I	Serial audio data input (1)			
DEM	3	1	De-emphasis enable (1)			
DGND	8	_	Digital ground			
FMT0	11	I	Audio data format select (1)			
FMT1	12	I	Audio data format select (1)			
IOUTL+	25	0	L-channel analog current output +			
IOUTL-	26	0	L-channel analog current output –			
IOUTR+	17	0	R-channel analog current output +			
IOUTR-	18	0	R-channel analog current output –			
IREF	20	_	Output current reference bias pin			
LRCK	4	I	Left and right clock (fg) input (1)			
MONO	1	- 1	Monaural mode enable (1)			
MUTE	10	- 1	Mute control (1)			
RST	14	I	Reset(1)			
SCK	7	I	System clock input ⁽¹⁾			
V _{CC} 1	23	_	Analog power supply, 5 V			
V _{CC} 2L	28	_	Analog power supply (L-channel DACFF), 5 V			
V _{CC} 2R	15	_	Analog power supply (R-cahnnel DACFF), 5 V			
VCOML	22	_	L-channel internal bias decoupling pin			
VCOMR	21	_	R-channel internal bias decoupling pin			
V_{DD}	9	_	Digital power supply, 3.3 V			
ZERO	13	0	Zero flag			

⁽¹⁾ Schmitt-trigger input, 5-V tolerant



FUNCTIONAL BLOCK DIAGRAM





TYPICAL PERFORMANCE CURVES

DIGITAL FILTER

Digital Filter Response

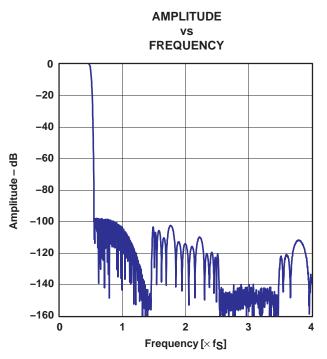


Figure 1. Frequency Response, Sharp Rolloff

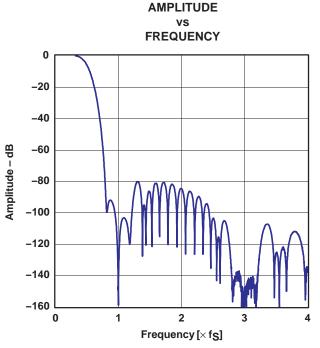


Figure 3. Frequency Response, Slow Rolloff

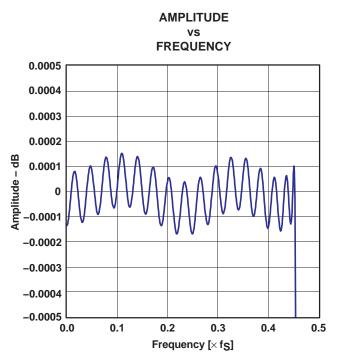


Figure 2. Pass-Band Ripple, Sharp Rolloff

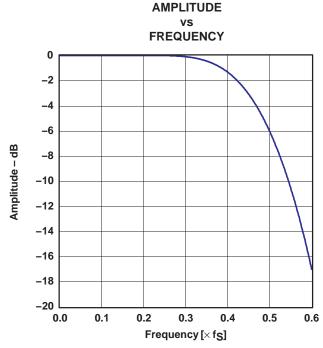
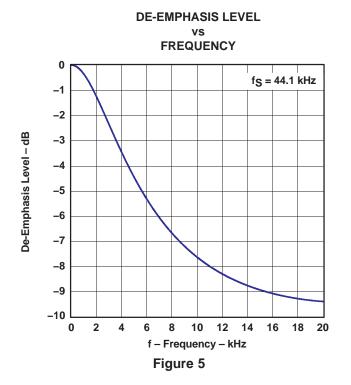
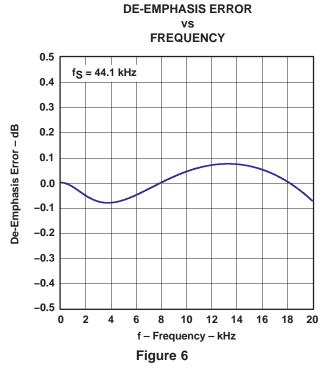


Figure 4. Transition Characteristics, Slow Rolloff



De-Emphasis Filter

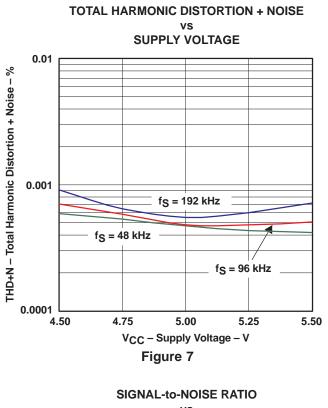


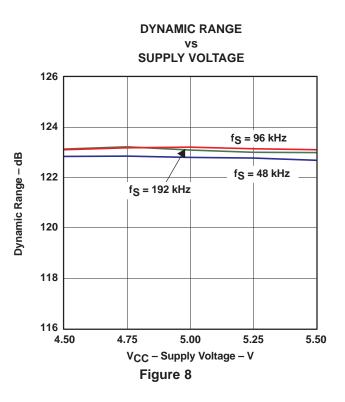


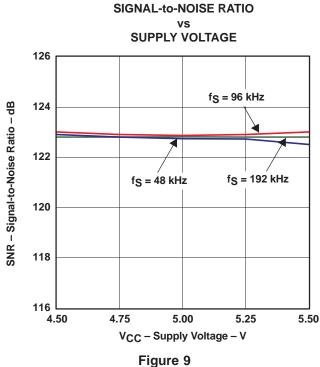


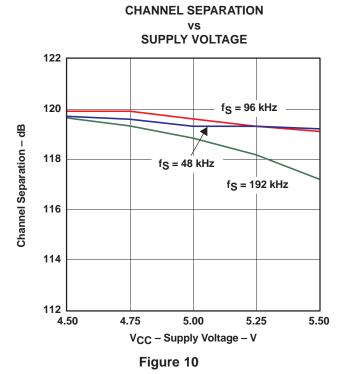
ANALOG DYNAMIC PERFORMANCE

Supply Voltage Characteristics





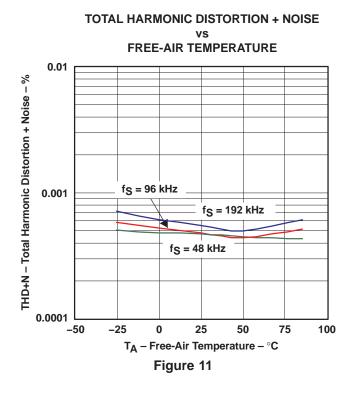


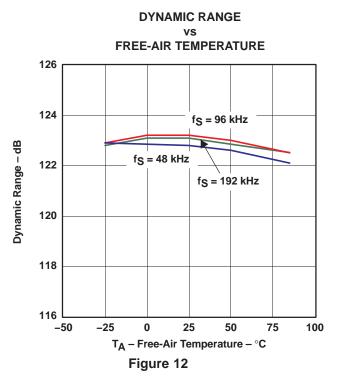


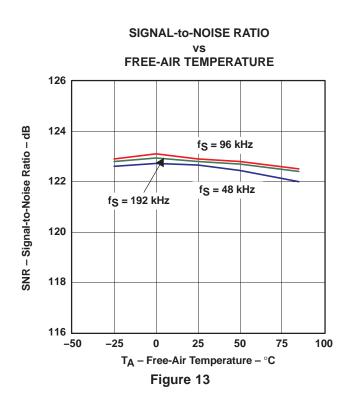
NOTE: PCM mode, $T_A = 25^{\circ}C$, $V_{DD} = 3.3$ V, measurement circuit is Figure 24.

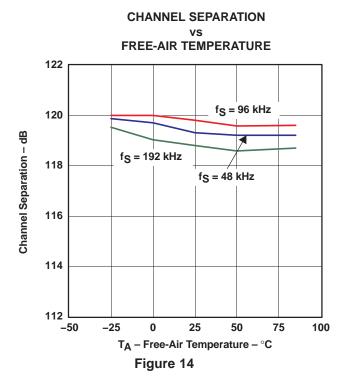


Temperature Characteristics



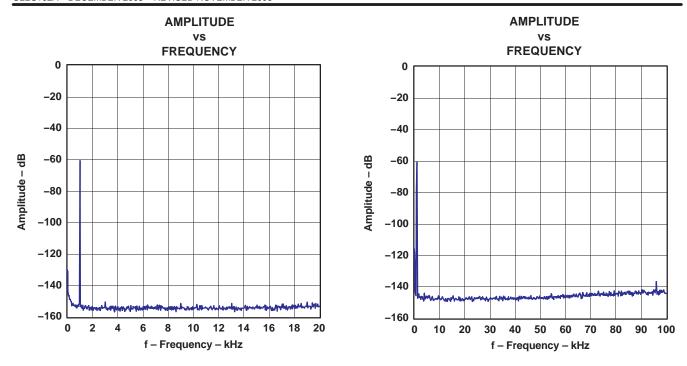






NOTE: PCM mode, V_{DD} = 3.3 V, V_{CC} = 5 V, measurement circuit is Figure 24.





NOTE: $f_S = 48$ kHz, 32768 point 8 average, $T_A = 25^{\circ}C$, $V_{DD} = 3.3$ V, NOTE: $f_S = 96$ kHz, 32768 point 8 average, $T_A = 25^{\circ}C$, $V_{DD} = 3.3$ V, $V_{CC} = 5$ V, measurement circuit is Figure 24.

Figure 15. -60-db Output Spectrum, BW = 20 kHz Figure 16. -60-db Output Spectrum, BW = 100 kHz

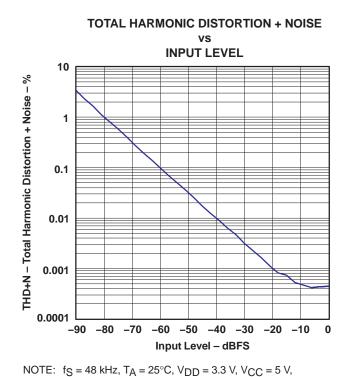


Figure 17. THD+N vs Input Level, PCM Mode

measurement circuit is Figure 24.



SYSTEM CLOCK AND RESET FUNCTIONS

System Clock Input

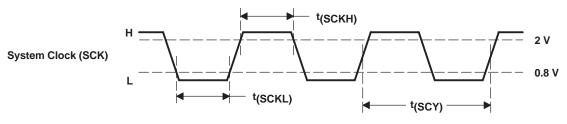
The PCM1798 requires a system clock for operating the digital interpolation filters and advanced segment DAC modulators. The system clock is applied at the SCK input (pin 7). The PCM1798 has a system clock detection circuit that automatically senses the frequency at which the system clock is operating. Table 1 shows examples of system clock frequencies for common audio sampling rates.

Figure 18 shows the timing requirements for the system clock input. For optimal performance, it is important to use a clock source with low phase jitter and noise. One of the Texas Instruments PLL1700 family of multiclock generators is an excellent choice for providing the PCM1798 system clock.

Table 1. System Clock Rates for Common Audio Sampling Frequencies

CAMPI INO EDECUENCY		(MHz)				
SAMPLING FREQUENCY	128 f _S	192 fg	256 fg	384 fg	512 f _S	768 fs
32 kHz	4.096	6.144	8.192	12.288	16.384	24.576
44.1 kHz	5.6488	8.4672	11.2896	16.9344	22.5792	33.8688
48 kHz	6.144	9.216	12.288	18.432	24.576	36.864
96 kHz	12.288	18.432	24.576	36.864	49.152	73.728
192 kHz	24.576	36.864	49.152	73.728	_(1)	_(1)

⁽¹⁾ This system clock rate is not supported for the given sampling frequency.



	PARAMETERS	MIN	MAX	UNITS
t(SCY)	System clock pulse cycle time	13		ns
t(SCKH)	System clock pulse duration, HIGH	0.4(SCY)		ns
t(SCKL)	System clock pulse duration, LOW	0.4(SCY)		ns

Figure 18. System Clock Input Timing



Power-On and External Reset Functions

The PCM1798 includes a power-on reset function. Figure 19 shows the operation of this function. With $V_{DD} > 2$ V, the power-on reset function is enabled. The initialization sequence requires 1024 system clocks from the time $V_{DD} > 2$ V.

The PCM1798 also includes an external reset capability using the RST input (pin 14). This allows an external controller or master reset circuit to force the PCM1798 to initialize to its default reset state.

Figure 20 shows the external reset operation and timing. The RST pin is set to logic 0 for a minimum of 20 ns. The RST pin is then set to a logic 1 state, thus starting the initialization sequence, which requires 1024 system clock periods. The external reset is especially useful in applications where there is a delay between the PCM1798 power up and system clock activation.

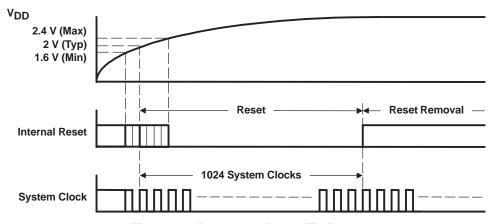


Figure 19. Power-On Reset Timing

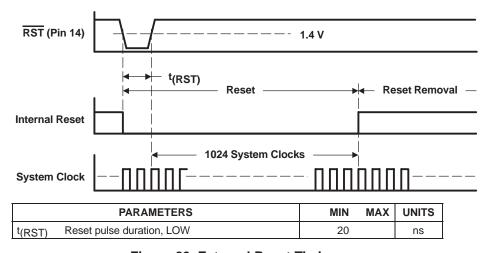


Figure 20. External Reset Timing



AUDIO DATA INTERFACE

Audio Serial Interface

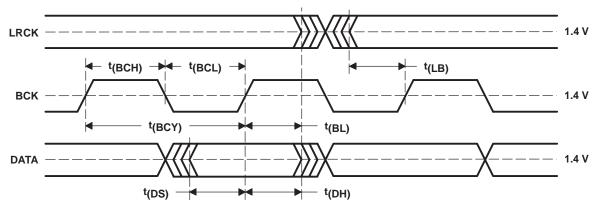
The audio interface port is a 3-wire serial port. It includes LRCK (pin 4), BCK (pin 6), and DATA (pin 5). BCK is the serial audio bit clock, and it is used to clock the serial data present on DATA into the serial shift register of the audio interface. Serial data is clocked into the PCM1798 on the rising edge of BCK. LRCK is the serial audio left/right word clock.

The PCM1798 requires the synchronization of LRCK and the system clock, but does not need a specific phase relation between LRCK and the system clock.

If the relationship between LRCK and the system clock changes more than ± 6 BCK, internal operation is initialized within $1/f_S$ and the analog outputs are forced to the bipolar zero level until resynchronization between LRCK and the system clock is completed.

PCM Audio Data Formats and Timing

The PCM1798 supports industry-standard audio data formats, including standard right-justified, I²S, and left-justified. The data formats are shown in Figure 22. Data formats are selected using FMT0 (pin 11) and FMT1 (pin 12) as shown in Table 2. All formats require binary twos-complement, MSB-first audio data. Figure 21 shows a detailed timing diagram for the serial audio interface.

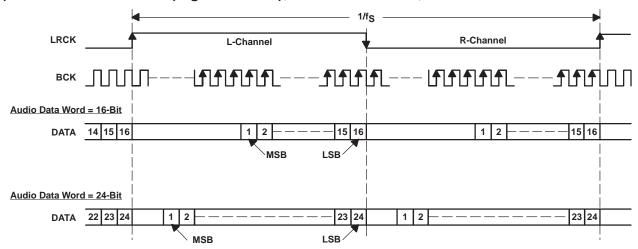


	PARAMETERS	MIN	MAX	UNITS
t(BCY)	BCK pulse cycle time	70		ns
t(BCL)	BCK pulse duration, LOW	30		ns
t(BCH)	BCK pulse duration, HIGH	30		ns
t(BL)	BCK rising edge to LRCK edge	10		ns
t(LB)	LRCK edge to BCK rising edge	10		ns
t(DS)	DATA setup time	10		ns
t(DH)	DATA hold time	10		ns
_	LRCK clock data	50% ± 2 bit clocks		

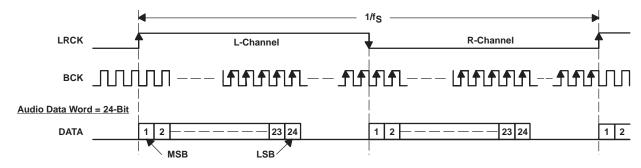
Figure 21. Timing of Audio Interface



(1) Standard Data Format (Right-Justified); L-Channel = HIGH, R-Channel = LOW



(2) Left-Justified Data Format; L-Channel = HIGH, R-Channel = LOW



(3) I²S Data Format; L-Channel = LOW, R-Channel = HIGH

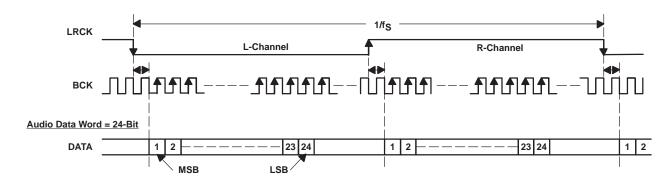


Figure 22. Audio Data Input Formats



FUNCTION DESCRIPTIONS

Audio data format

Audio format is selected using FMT0 (pin 11) and FMT1 (pin 12). The PCM1798 also supports monaural mode and DF bypass mode using MONO (pin 1) and CHSL (pin 2). The PCM1798 can select the DF rolloff characteristics.

Table 2. Audio Data Format Select

MONO	CHSL	FMT1	FMT0	FORMAT	STEREO/MONO	DF ROLLOFF
0	0	0	0	I ² S	Stereo	Sharp
0	0	0	1	Left-justified format	Stereo	Sharp
0	0	1	0	Standard, 16-bit	Stereo	Sharp
0	0	1	1	Standard, 24-bit	Stereo	Sharp
0	1	0	0	I ² S	Stereo	Slow
0	1	0	1	Left-justified format	Stereo	Slow
0	1	1	0	Standard, 16-bit	Stereo	Slow
0	1	1	1	Digital filter bypass	Mono	-
1	0	0	0	I ² S	Mono, L-channel	Sharp
1	0	0	1	Left-justified format	Mono, L-channel	Sharp
1	0	1	0	Standard, 16-bit	Mono, L-channel	Sharp
1	0	1	1	Standard, 24-bit	Mono, L-channel	Sharp
1	1	0	0	I ² S	Mono, R-channel	Sharp
1	1	0	1	Left-justified format	Mono, R-channel	Sharp
1	1	1	0	Standard, 16-bit	Mono, R-channel	Sharp
1	1	1	1	Standard, 24-bit	Mono, R-channel	Sharp

Soft Mute

The PCM1798 supports mute operation. When MUTE (pin 10) is set to HIGH, both analog outputs are transitioned to the bipolar zero level in -0.5-dB steps with a transition speed of $1/f_S$ per step. This system provides pop-free muting of the DAC output.

De-Emphasis

The PCM1798 has a de-emphasis filter for the sampling frequency of 44.1 kHz. The de-emphasis filter is controlled using DEM (pin 3).

Zero Detection

When the PCM1798 detects that the audio input data in the L-channel and the R-channel is continuously zero for 1024 LRCKs in the PCM mode, or that the audio input data is continuously zero for 1024 WDCKs in the external filter mode, the PCM1798 sets ZERO (pin 13) to HIGH.



APPLICATION INFORMATION

TYPICAL CONNECTION DIAGRAM

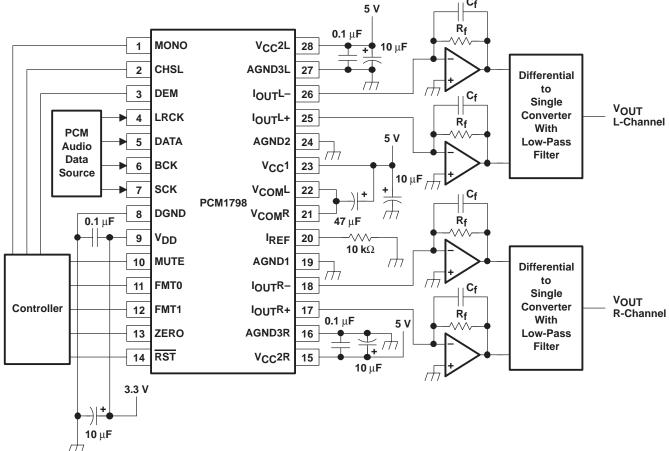


Figure 23. Typical Application Circuit

APPLICATION CIRCUIT

The design of the application circuit is very important in order to actually realize the high S/N ratio of which the PCM1798 is capable. This is because noise and distortion that are generated in an application circuit are not negligible.

In the third-order LPF circuit of Figure 24, the output level is 2.1 V RMS, and 123 dB S/N is achieved.

I/V Section

The current of the PCM1798 on each of the output pins (IOUTL+, IOUTL-, IOUTR+, IOUTR-) is 4 mA p-p at 0 dB (full scale). The voltage output level of the I/V converter (Vi) is given by following equation:

$$Vi = 4 \text{ mA p-p} \times R_f (R_f : feedback resistance of I/V converter)$$

An NE5534 operational amplifier is recommended for the I/V circuit to obtain the specified performance. Dynamic performance such as the gain bandwidth, settling time, and slew rate of the operational amplifier affects the audio dynamic performance of the I/V section.

Differential Section

The PCM1798 voltage outputs are followed by differential amplifier stages, which sum the differential signals for each channel, creating a single-ended I/V op-amp output. In addition, the differential amplifiers provide a low-pass filter function.

The operational amplifier recommended for the differential circuit is the low-noise type.



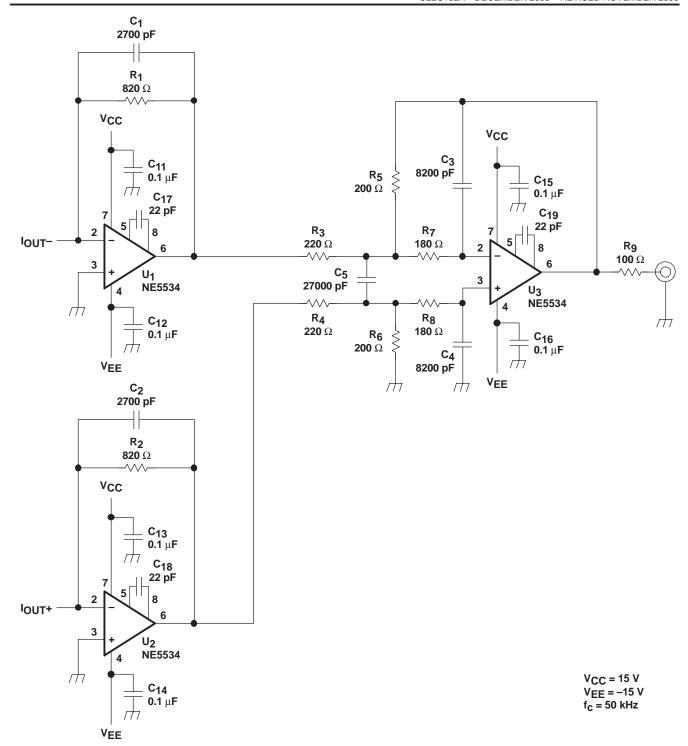


Figure 24. Measurement Circuit



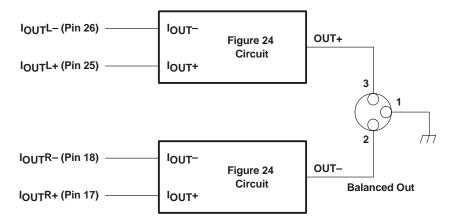


Figure 25. Measurement Circuit for Monaural Mode



APPLICATION FOR EXTERNAL DIGITAL FILTER INTERFACE

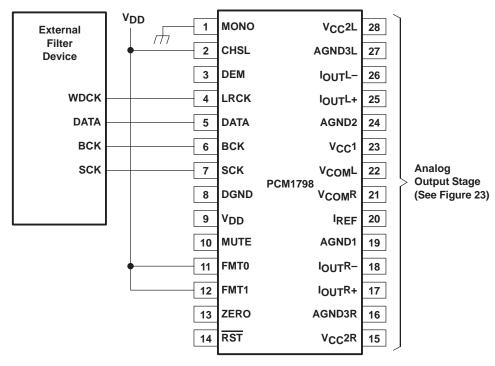


Figure 26. Connection Diagram for External Digital Filter (Internal DF Bypass Mode) Application

Application for Interfacing With an External Digital Filter

For some applications, it may be desirable to use a programmable digital signal processor as an external digital filter to perform the interpolation function. The following pin settings enable the external digital filter application mode.

- MONO (pin 1) = LOW
- CHSL (Pin 2) = HIGH
- FMT0 (Pin 11) = HIGH
- FMT1 (pin 12) = HIGH

The pins used to provide the serial interface for the external digital filter are shown in the connection diagram of Figure 26. The word clock (WDCK) must be operated at 8× or 4× the desired sampling frequency, f_S.

Pin Assignment When Using the External Digital Filter Interface

- LRCK (pin 4): WDCK as word clock input
- DATA (pin 5): Monaural audio data input
- BCK (pin 6): Bit clock input



Audio Format

The PCM1798 in the external digital filter interface mode supports the 24-bit right-justified audio format as shown in Figure 27.

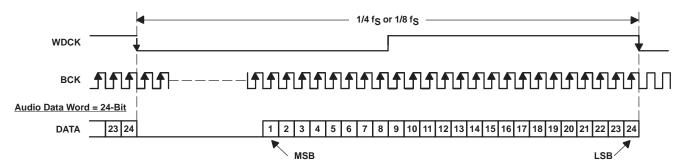
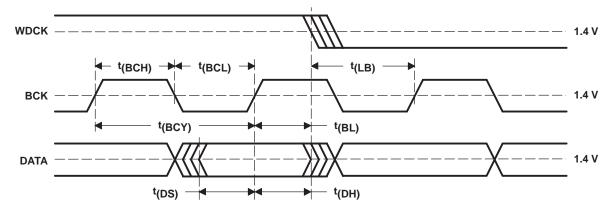


Figure 27. Audio Data Input Format for External Digital Filter (Internal DF Bypass Mode) Application

System Clock (SCK) and Interface Timing

The PCM1798 in an application using an external digital filter requires the synchronization of WDCK and the system clock. The system clock is phase-free with respect to WDCK. Interface timing among WDCK, BCK, and DATA is shown in Figure 28.



	PARAMETER	MIN	MAX	UNITS
t(BCY)	BCK pulse cycle time	20		ns
t(BCL)	BCK pulse duration, LOW	7		ns
t(BCH)	BCK pulse duration, HIGH	7		ns
t(BL)	BCK rising edge to WDCK falling edge	5		ns
t(LB)	WDCK falling edge to BCK rising edge	5		ns
t(DS)	DATA setup time	5		ns
t(DH)	DATA hold time	5		ns

Figure 28. Audio Interface Timing for External Digital Filter (Internal DF Bypass Mode) Application



ANALOG OUTPUT

Table 3 and Figure 29 show the relationship between the digital input code and analog output.

Table 3. Analog Output Current and Voltage

	800000 (-FS)	000000 (BPZ)	7FFFFF (+FS)		
IOUTN [mA]	-1.5	-3.5	-5.5		
IOUTP [mA]	-5.5	-3.5	-1.5		
V _{OUT} N [V]	-1.23	-2.87	-4.51		
V _{OUT} P [V]	-4.51	-2.87	-1.23		
VOUT [V]	-2.98	0	2.98		

NOTE: V_{OUT}N is the output of U1, V_{OUT}P is the output of U2, and V_{OUT} is the output of U3 in the measurement circuit of Figure 24.

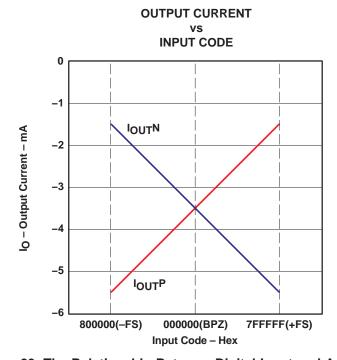


Figure 29. The Relationship Between Digital Input and Analog Output



PACKAGE OPTION ADDENDUM

17-May-2014

PACKAGING INFORMATION

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Orderable Device	Status	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Device Marking	Samples
PCM1798DB	ACTIVE	SSOP	DB	28	47	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-25 to 85	PCM1798	Samples
PCM1798DBG4	ACTIVE	SSOP	DB	28	47	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-25 to 85	PCM1798	Samples
PCM1798DBR	ACTIVE	SSOP	DB	28	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-25 to 85	PCM1798	Samples
PCM1798DBRG4	ACTIVE	SSOP	DB	28		TBD	Call TI	Call TI	-25 to 85		Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead/Ball Finish Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.



PACKAGE OPTION ADDENDUM

17-May-2014

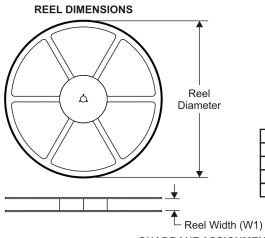
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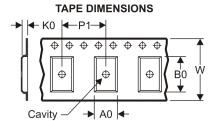
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PACKAGE MATERIALS INFORMATION

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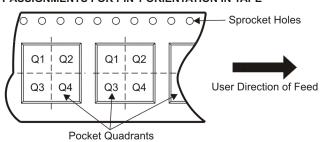
TAPE AND REEL INFORMATION





	40	Dimension designed to accommodate the component width
		Dimension designed to accommodate the component length
П	K0	Dimension designed to accommodate the component thickness
	W	Overall width of the carrier tape
П	P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device	Package Type	Package Drawing			Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
PCM1798DBR	SSOP	DB	28	2000	330.0	17.4	8.5	10.8	2.4	12.0	16.0	Q1

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*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)	
PCM1798DBR	SSOP	DB	28	2000	336.6	336.6	28.6	

DB (R-PDSO-G**)

PLASTIC SMALL-OUTLINE

28 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-150

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